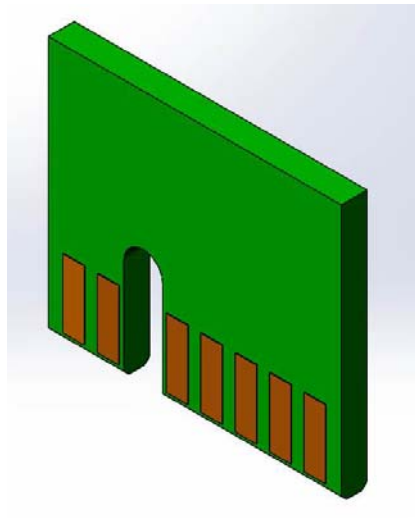
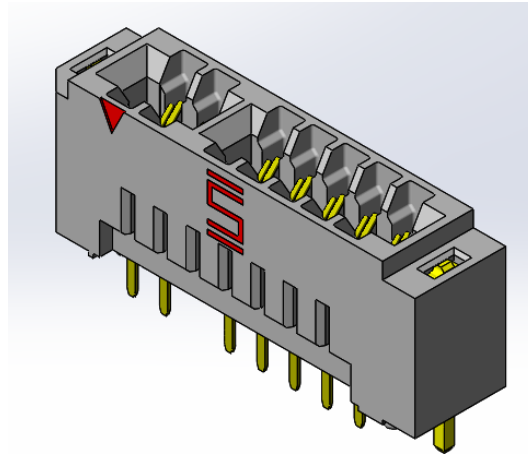




Project Number: Design Qualification Test Report	Tracking Code: 502396_Report_Rev_1
Requested by: Abbie Yang	Date: 5/11/2015
Part #: MEC2-30-01-L-TH1-WT/EDGE CARD	
Part description: MEC2/CARD	Tech: Kason He
Test Start: 2/9/2015	Test Completed: 3/28/2015



(Actual part not depicted)

## DESIGN QUALIFICATION TEST REPORT

MEC2/CARD  
MEC2-30-01-L-TH1-WT/EDGE CARD

Tracking Code: 502396 Report Rev 1	Part #: MEC2-30-01-L-TH1-WT/EDGE CARD
Part description: MEC2/CARD	

**REVISION HISTORY**

DATE	REV.NUM.	DESCRIPTION	ENG
5/11/2015	1	Initial Issue	KH

## CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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## SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

## APPLICABLE DOCUMENTS

Standards: EIA Publication 364

## TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free
- 9) Samtec Test PCBs used: PCB-106652-TST/PCB-106653-TST/PCB-106654-TST/PCB-106655-TST  
PCB-106656-TST/PCB-106657-TST

**FLOWCHARTS****Gas Tight**

Group 1  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .056" thick edge card (min)*

**Step Description**

1. LLCR <sup>(2)</sup>
2. Gas Tight <sup>(1)</sup>
3. LLCR <sup>(2)</sup>  
Max Delta = 15 mOhm

(1) Gas Tight = EIA-364-36

(2) LLCR = EIA-364-23  
Open Circuit Voltage = 20 mV Max  
Test Current = 100 mA Max

**Normal Force**

Group 1  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Contacts Minimum  
Signal Without Thermals

*Note: .068" thick edge card (max)*

**Step Description**

1. Contact Gaps
2. Normal Force <sup>(1)</sup>  
Deflection = .025 "  
Expected Force at Max Deflection = 80 g

Group 2  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Contacts Minimum  
Signal With Thermals

*Note: .068" thick edge card (max)*

**Step Description**

1. Contact Gaps
2. Thermal Age <sup>(2)</sup>
3. Contact Gaps
4. Normal Force <sup>(1)</sup>  
Deflection = .025 "  
Expected Force at Max Deflection = 80 g

(1) Normal Force = EIA-364-04

(2) Thermal Age = EIA-364-17  
Test Condition = 4 (105°C)  
Time Condition = B (250 Hours)

## FLOWCHARTS Continued

**Thermal Aging**Group 1

MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	Contact Gaps
2.	Mating/Unmating Force (2)
3.	LLCR (1)
4.	Thermal Age (3)
5.	LLCR (1) Max Delta = 15 mOhm
6.	Mating/Unmating Force (2)
7.	Contact Gaps

Group 2

MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .068" thick edge card (max)*

Step	Description
1.	Contact Gaps
2.	Mating/Unmating Force (2)
3.	LLCR (1)
4.	Thermal Age (3)
5.	LLCR (1) Max Delta = 15 mOhm
6.	Mating/Unmating Force (2)
7.	Contact Gaps

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max  
Test Current = 100 mA Max

(2) Mating/Unmating Force = EIA-364-13

(3) Thermal Age = EIA-364-17

Test Condition = 4 (105°C)  
Time Condition = B (250 Hours)

## FLOWCHARTS Continued

**Mating/Unmating/Durability**

Group 1  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	Contact Gaps
2.	LLCR <sup>(2)</sup>
3.	Mating/Unmating Force <sup>(3)</sup>
4.	Cycles Quantity = 25 Cycles
5.	Mating/Unmating Force <sup>(3)</sup>
6.	Cycles Quantity = 25 Cycles
7.	Mating/Unmating Force <sup>(3)</sup>
8.	Cycles Quantity = 25 Cycles
9.	Mating/Unmating Force <sup>(3)</sup>
10.	Cycles Quantity = 25 Cycles
11.	Mating/Unmating Force <sup>(3)</sup>
12.	Contact Gaps
13.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
14.	Thermal Shock <sup>(4)</sup>
15.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
16.	Humidity <sup>(1)</sup>
17.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
18.	Mating/Unmating Force <sup>(3)</sup>

Group 2  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .068" thick edge card (max)*

Step	Description
1.	Contact Gaps
2.	LLCR <sup>(2)</sup>
3.	Mating/Unmating Force <sup>(3)</sup>
4.	Cycles Quantity = 25 Cycles
5.	Mating/Unmating Force <sup>(3)</sup>
6.	Cycles Quantity = 25 Cycles
7.	Mating/Unmating Force <sup>(3)</sup>
8.	Cycles Quantity = 25 Cycles
9.	Mating/Unmating Force <sup>(3)</sup>
10.	Cycles Quantity = 25 Cycles
11.	Mating/Unmating Force <sup>(3)</sup>
12.	Contact Gaps
13.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
14.	Thermal Shock <sup>(4)</sup>
15.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
16.	Humidity <sup>(1)</sup>
17.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
18.	Mating/Unmating Force <sup>(3)</sup>

Group 3  
MEC2-05-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .068" thick edge card (max)*

Step	Description
1.	Contact Gaps
2.	Mating/Unmating Force <sup>(3)</sup>
3.	Cycles Quantity = 25 Cycles
4.	Mating/Unmating Force <sup>(3)</sup>
5.	Cycles Quantity = 25 Cycles
6.	Mating/Unmating Force <sup>(3)</sup>
7.	Cycles Quantity = 25 Cycles
8.	Mating/Unmating Force <sup>(3)</sup>
9.	Cycles Quantity = 25 Cycles
10.	Mating/Unmating Force <sup>(3)</sup>

Group 4  
MEC2-50-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .068" thick edge card (max)*

Step	Description
1.	Contact Gaps
2.	Mating/Unmating Force <sup>(3)</sup>
3.	Cycles Quantity = 25 Cycles
4.	Mating/Unmating Force <sup>(3)</sup>
5.	Cycles Quantity = 25 Cycles
6.	Mating/Unmating Force <sup>(3)</sup>
7.	Cycles Quantity = 25 Cycles
8.	Mating/Unmating Force <sup>(3)</sup>
9.	Cycles Quantity = 25 Cycles
10.	Mating/Unmating Force <sup>(3)</sup>

- 
- (1) Humidity = EIA-364-31  
Test Condition = B (240 Hours)  
Test Method = III (+25oC to +65tC @ 90% RH to 98% RH)  
Test Exceptions: ambient pre-condition and delete steps 7a and 7b
- (2) LLCR = EIA-364-23  
Open Circuit Voltage = 20 mV Max  
Test Current = 100 mA Max
- (3) Mating/Unmating Force = EIA-364-13
- (4) Thermal Shock = EIA-364-32  
Exposure Time at Temperature Extremes = 1/2 Hour  
Method A, Test Condition = I (-55oC to +85tC)  
Test Duration = A-3 (100 Cycles)

## FLOWCHARTS Continued

**IR/DWV****Pin-to-Pin**

Group 1  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown (2)

Group 2  
MEC2-30-01-L-TH1-WT  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown (3)

Group 3  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown (3)

Group 4  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	IR (5)
2.	DWV at Test Voltage (1)
3.	Thermal Shock (5)
4.	IR (5)
5.	DWV at Test Voltage (1)
6.	Humidity (4)
7.	IR (5)
8.	DWV at Test Voltage (1)

**Row-to-Row**

Group 5  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown (3)

Group 6  
MEC2-30-01-L-TH1-WT  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown (3)

Group 7  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown (3)

Group 8  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	IR (5)
2.	DWV at Test Voltage (1)
3.	Thermal Shock (5)
4.	IR (5)
5.	DWV at Test Voltage (1)
6.	Humidity (4)
7.	IR (5)
8.	DWV at Test Voltage (1)

## FLOWCHARTS Continued

**Pin-to-Closest Metallic Hardware**

Group 9  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown <sup>(3)</sup>

Group 10  
MEC2-30-01-L-TH1-WT  
  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown <sup>(3)</sup>

Group 11  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	DWV Breakdown <sup>(3)</sup>

Group 12  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
2 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	IR <sup>(5)</sup>
2.	DWV at Test Voltage <sup>(1)</sup>
3.	Thermal Shock <sup>(6)</sup>
4.	IR <sup>(5)</sup>
5.	DWV at Test Voltage <sup>(1)</sup>
6.	Humidity <sup>(4)</sup>
7.	IR <sup>(5)</sup>
8.	DWV at Test Voltage <sup>(1)</sup>

- 
- (1) DWV at Test Voltage = EIA-364-20  
Test Condition = 1 (Sea Level)  
DWV test voltage is equal to 75% of the lowest breakdown voltage  
Test voltage applied for 60 seconds
- (2) DWV Breakdown = EIA-364-20  
Test Condition = 1 (Sea Level)  
DWV test voltage is equal to 75% of the lowest breakdown voltage  
Test voltage applied for 60 seconds
- (3) DWV Breakdown = EIA-364-20  
Test Condition = 1 (Sea Level)  
DWV test voltage is equal to 75% of the lowest breakdown voltage  
Test voltage applied for 60 seconds
- (4) Humidity = EIA-364-31  
Test Condition = B (240 Hours)  
Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)  
Test Exceptions: ambient pre-condition and delete steps 7a and 7b
- (5) IR = EIA-364-21  
Test Condition = 500 Vdc, 2 Minutes Max
- (6) Thermal Shock = EIA-364-32  
Exposure Time at Temperature Extremes = 1/2 Hour  
Method A, Test Condition = I (-55°C to +85°C)  
Test Duration = A-3 (100 Cycles)

Tracking Code: 502396 Report Rev 1	Part #: MEC2-30-01-L-TH1-WT/EDGE CARD
Part description: MEC2/CARD	

### FLOWCHARTS Continued

#### Current Carrying Capacity

<p><u>Group 1</u> MEC2-50-01-L-TH1-WT MATING-CARD 2 Pins Powered Signal <i>Note: 50 POS.056" thick edge card (min)</i></p>		<p><u>Group 2</u> MEC2-50-01-L-TH1-WT MATING-CARD 4 Pins Powered Signal <i>Note: 50 POS.056" thick edge card (min)</i></p>		<p><u>Group 3</u> MEC2-50-01-L-TH1-WT MATING-CARD 6 Pins Powered Signal <i>Note: 50 POS.056" thick edge card (min)</i></p>		<p><u>Group 4</u> MEC2-50-01-L-TH1-WT MATING-CARD 8 Pins Powered Signal <i>Note: 50 POS.056" thick edge card (min)</i></p>	
Step	Description	Step	Description	Step	Description	Step	Description
1.	CCC <sup>(1)</sup> Rows = 2 Number of Positions = 1	1.	CCC <sup>(1)</sup> Rows = 2 Number of Positions = 2	1.	CCC <sup>(1)</sup> Rows = 2 Number of Positions = 3	1.	CCC <sup>(1)</sup> Rows = 2 Number of Positions = 4

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<p><u>Group 5</u> MEC2-50-01-L-TH1-WT MATING-CARD 100 Pins Powered Signal <i>Note: 50 POS.056" thick edge card (min)</i></p>	
Step	Description
1.	CCC <sup>(1)</sup> Rows = 2 Number of Positions = 50

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(1) CCC = EIA-364-70  
Method 2, Temperature Rise Versus Current Curve  
(TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C  
(GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

## FLOWCHARTS Continued

**Mechanical Shock/Random Vibration/LLCR**

Group 1  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .056" thick edge card (min)*

Step	Description
1.	LLCR <sup>(1)</sup>
2.	Mechanical Shock <sup>(2)</sup>
3.	Random Vibration <sup>(3)</sup>
4.	LLCR <sup>(1)</sup> Max Delta = 15 mOhm

Group 2  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
8 Assemblies

*Note: .068" thick edge card (max)*

Step	Description
1.	LLCR <sup>(1)</sup>
2.	Mechanical Shock <sup>(2)</sup>
3.	Random Vibration <sup>(3)</sup>
4.	LLCR <sup>(1)</sup> Max Delta = 15 mOhm

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(2) Mechanical Shock = EIA-364-27

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(3) Random Vibration = EIA-364-28

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

**Mechanical Shock/Random Vibration/Event Detection**

Group 1  
MEC2-30-01-L-TH1-WT  
MATING-CARD  
60 Points

*Note: .056" thick edge card (min)*

Step	Description
1.	Nanosecond Event Detection (Mechanical Shock) <sup>(1)</sup>
2.	Nanosecond Event Detection (Random Vibration) <sup>(2)</sup>

(1) Nanosecond Event Detection (Mechanical Shock)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-27 for Mechanical Shock:

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

(2) Nanosecond Event Detection (Random Vibration)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-28 for Random Vibration:

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

**ATTRIBUTE DEFINITIONS**

The following is a brief, simplified description of attributes.

**THERMAL SHOCK:**

- 1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors*.
- 2) Test Condition 1: -55°C to +85°C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

**THERMAL:**

- 1) EIA-364-17, *Temperature Life with or without Electrical Load Test Procedure for Electrical Connectors*.
- 2) Test Condition 4 at 105° C
- 3) Test Time Condition B for 250 hours.
- 4) All test samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

**HUMIDITY:**

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors*.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

**MECHANICAL SHOCK (Specified Pulse):**

- 1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
- 2) Test Condition C
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Half Sine
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

**VIBRATION:**

- 1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: 0.04 G<sup>2</sup> / Hz
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

**NANOSECOND-EVENT DETECTION:**

- 1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

**MATING/UNMATING:**

- 1) Reference document: EIA-364-13, *Mating and Unmating Forces Test Procedure for Electrical Connectors*.
- 2) The full insertion position was to within 0.003" to 0.004" of the plug bottoming out in the receptacle to prevent damage to the system under test.
- 3) One of the mating parts is secured to a floating X-Y table to prevent damage during cycling.

**ATTRIBUTE DEFINITIONS Continued**

The following is a brief, simplified description of attributes.

**TEMPERATURE RISE (Current Carrying Capacity, CCC):**

- 1) EIA-364-70, *Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets*.
- 2) When current passes through a contact, the temperature of the contact increases as a result of  $I^2R$  (resistive) heating.
- 3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
- 4) The size of the temperature probe can affect the measured temperature.
- 5) Copper traces on PC boards will contribute to temperature rise:
  - a. Self heating (resistive)
  - b. Reduction in heat sink capacity affecting the heated contacts
- 6) A de-rating curve, usually 20%, is calculated.
- 7) Calculated de-rated currents at four temperature points are reported:
  - a. Ambient
  - b. 85° C
  - c. 95° C
  - d. 115° C
- 8) Typically, neighboring contacts (in close proximity to maximize heat build up) are energized.
- 9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
- 10) A computer program, *TR 803.exe*, ensures accurate stability for data acquisition.
- 11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
- 12) Hook-up wire length is longer than the minimum specified in the referencing standard.

**LLCR:**

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
  - a.  $\leq +5.0$  mOhms: ----- Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: ----- Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: ----- Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: ----- Marginal
  - e.  $+50.1$  to  $+2000$  mOhms: ----- Unstable
  - f.  $>+2000$  mOhms: ----- Open Failure

**ATTRIBUTE DEFINITIONS Continued**

The following is a brief, simplified description of attributes.

**GAS TIGHT:**

To provide method for evaluating the ability of the contacting surfaces in preventing penetration of harsh vapors which might lead to oxide formation that may degrade the electrical performance of the contact system.

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
  - a.  $\leq +5.0$  mOhms: ----- Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: ----- Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: ----- Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: ----- Marginal
  - e.  $+50.1$  to  $+2000$  mOhms: ----- Unstable
  - f.  $>+2000$  mOhms: ----- Open Failure
- 4) Procedure:
  - a. Reference document: EIA-364-36, *Test Procedure for Determination of Gas-Tight Characteristics for Electrical Connectors, Sockets and/or Contact Systems*.
  - b. Test Conditions:
    - i. Class II--- Mated pairs of contacts assembled to their plastic housings.
    - ii. Reagent grade Nitric Acid shall be used of sufficient volume to saturate the test chamber
    - iii. The ratio of the volume of the test chamber to the surface area of the acid shall be 10:1.
    - iv. The chamber shall be saturated with the vapor for at least 15 minutes before samples are added.
    - v. Exposure time, 55 to 65 minutes.
    - vi. The samples shall be no closer to the chamber walls than 1 inches and no closer to the surface of the acid than 3 inches.
    - vii. The samples shall be dried after exposure for a minimum of 1 hour.
    - viii. Drying temperature  $50^{\circ}\text{C}$
    - ix. The final LLCR shall be conducted within 1 hour after drying.

**ATTRIBUTE DEFINITIONS Continued**

The following is a brief, simplified description of attributes

**NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):**

- 1) Reference document: EIA-364-04, *Normal Force Test Procedure for Electrical Connectors*.
- 2) The contacts shall be tested in the connector housing.
- 3) If necessary, a “window” shall be made in the connector body to allow a probe to engage and deflect the contact at the same attitude and distance (plus 0.05 mm [0.002”]) as would occur in actual use.
- 4) The connector housing shall be placed in a holding fixture that does not interfere with or otherwise influence the contact force or deflection.
- 5) Said holding fixture shall be mounted on a floating, adjustable, X-Y table on the base of the Dillon TC<sup>2</sup>, computer controlled test stand with a deflection measurement system accuracy of 5.0 µm (0.0002”).
- 6) The nominal deflection rate shall be 5 mm (0.2”)/minute.
- 7) Unless otherwise noted a minimum of five contacts shall be tested.
- 8) The force/deflection characteristic to load and unload each contact shall be repeated five times.
- 9) The system shall utilize the TC<sup>2</sup> software in order to acquire and record the test data.
- 10) The permanent set of each contact shall be measured within the TC<sup>2</sup> software.
- 11) The acquired data shall be graphed with the deflection data on the X-axis and the force data on the Y-axis and a print out will be stored with the Tracking Code paperwork.

**ATTRIBUTE DEFINITIONS Continued**

The following is a brief, simplified description of attributes

**INSULATION RESISTANCE (IR):**

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
  - a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
  - b. Test Conditions:
    - i. Between Adjacent Contacts or Signal-to-Ground
    - ii. Electrification Time 2.0 minutes
    - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

**DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

- 1) PROCEDURE:
  - a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
  - b. Test Conditions:
    - i. Between Adjacent Contacts or Signal-to-Ground
    - ii. Barometric Test Condition 1
    - iii. Rate of Application 500 V/Sec
    - iv. Test Voltage (VAC) until breakdown occurs
- 2) MEASUREMENTS/CALCULATIONS
  - a. The breakdown voltage shall be measured and recorded.
  - b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
  - c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

## RESULTS

### Temperature Rise, CCC at a 20% de-rating

- CCC for a 30°C Temperature Rise -----4.9 A per contact with 2 contacts (2 x 1) powered
- CCC for a 30°C Temperature Rise -----4.2 A per contact with 4 contacts (2 x 2) powered
- CCC for a 30°C Temperature Rise -----3.7 A per contact with 6 contacts (2 x 3) powered
- CCC for a 30°C Temperature Rise -----3.2 A per contact with 8 contacts (2 x 4) powered
- CCC for a 30°C Temperature Rise -----1.9 A per contact with 98 contacts (2 x 49) powered

### Mating/Unmating Forces

#### Thermal Aging Group

#### MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"

- Initial
  - Mating
    - Min ----- 9.32 Lbs
    - Max -----10.68 Lbs
  - Unmating
    - Min ----- 3.66 Lbs
    - Max ----- 4.33 Lbs
- After Thermal
  - Mating
    - Min ----- 8.80 Lbs
    - Max -----10.01 Lbs
  - Unmating
    - Min ----- 3.92 Lbs
    - Max ----- 4.09 Lbs

#### MEC2-30-01-L-TH1-WT /EDGE CARD 0.068"

- Initial
  - Mating
    - Min -----11.78 Lbs
    - Max ----- 14.21 Lbs
  - Unmating
    - Min ----- 3.25 Lbs
    - Max ----- 5.26 Lbs
- After Thermal
  - Mating
    - Min -----10.15 Lbs
    - Max -----11.70 Lbs
  - Unmating
    - Min ----- 3.04 Lbs
    - Max ----- 3.93 Lbs

**RESULTS Continued****Mating/Unmating Forces****Mating-Unmating Durability Group (MEC2-30-01-L-TH1-WT/EDGE CARD 0.056")**

- **Initial**
  - **Mating**
    - **Min** ----- 7.26 Lbs
    - **Max** ----- 9.54 Lbs
  - **Unmating**
    - **Min** ----- 3.24 Lbs
    - **Max** ----- 4.16 Lbs
- **After 25 Cycles**
  - **Mating**
    - **Min** ----- 9.74 Lbs
    - **Max** ----- 12.11 Lbs
  - **Unmating**
    - **Min** ----- 4.27 Lbs
    - **Max** ----- 5.14 Lbs
- **After 50 Cycles**
  - **Mating**
    - **Min** ----- 10.70 Lbs
    - **Max** ----- 14.43 Lbs
  - **Unmating**
    - **Min** ----- 4.87 Lbs
    - **Max** ----- 5.97 Lbs
- **After 75 Cycles**
  - **Mating**
    - **Min** ----- 11.85 Lbs
    - **Max** ----- 15.50 Lbs
  - **Unmating**
    - **Min** ----- 5.21 Lbs
    - **Max** ----- 6.68 Lbs
- **After 100 Cycles**
  - **Mating**
    - **Min** ----- 12.19 Lbs
    - **Max** ----- 16.34 Lbs
  - **Unmating**
    - **Min** ----- 5.52 Lbs
    - **Max** ----- 7.38 Lbs
- **Humidity**
  - **Mating**
    - **Min** ----- 6.09 Lbs
    - **Max** ----- 8.39 Lbs
  - **Unmating**
    - **Min** ----- 3.00 Lbs
    - **Max** ----- 4.08 Lbs

**RESULTS Continued****Mating/Unmating Forces****Mating-Unmating Durability Group (MEC2-30-01-L-TH1-WT/EDGE CARD 0.068")**

- **Initial**
  - **Mating**
    - **Min** -----11.01 Lbs
    - **Max** -----13.76 Lbs
  - **Unmating**
    - **Min** -----3.31 Lbs
    - **Max** -----4.29 Lbs
- **After 25 Cycles**
  - **Mating**
    - **Min** -----12.59 Lbs
    - **Max** -----15.61 Lbs
  - **Unmating**
    - **Min** -----4.23 Lbs
    - **Max** -----5.58 Lbs
- **After 50 Cycles**
  - **Mating**
    - **Min** -----13.37 Lbs
    - **Max** -----18.00 Lbs
  - **Unmating**
    - **Min** -----4.70 Lbs
    - **Max** -----6.82 Lbs
- **After 75 Cycles**
  - **Mating**
    - **Min** -----13.84 Lbs
    - **Max** -----18.92 Lbs
  - **Unmating**
    - **Min** -----6.02 Lbs
    - **Max** -----8.44 Lbs
- **After 100 Cycles**
  - **Mating**
    - **Min** -----14.25 Lbs
    - **Max** -----19.46 Lbs
  - **Unmating**
    - **Min** -----6.41 Lbs
    - **Max** -----9.06 Lbs
- **Humidity**
  - **Mating**
    - **Min** -----8.17 Lbs
    - **Max** -----10.76 Lbs
  - **Unmating**
    - **Min** -----2.87 Lbs
    - **Max** -----3.52 Lbs

**RESULTS Continued****Mating/Unmating Forces****Mating-Unmating Basic Group (MEC2-05-01-L-TH1-WT/EDGE CARD 0.068")**

- **Initial**
  - **Mating**
    - **Min** ----- 1.32 Lbs
    - **Max** ----- 1.73 Lbs
  - **Unmating**
    - **Min** ----- 0.41 Lbs
    - **Max** ----- 0.55 Lbs
- **After 25 Cycles**
  - **Mating**
    - **Min** ----- 1.47 Lbs
    - **Max** ----- 1.75 Lbs
  - **Unmating**
    - **Min** ----- 0.55 Lbs
    - **Max** ----- 0.74 Lbs
- **After 50 Cycles**
  - **Mating**
    - **Min** ----- 1.32 Lbs
    - **Max** ----- 1.93 Lbs
  - **Unmating**
    - **Min** ----- 0.62 Lbs
    - **Max** ----- 0.82 Lbs
- **After 75 Cycles**
  - **Mating**
    - **Min** ----- 1.37 Lbs
    - **Max** ----- 2.02 Lbs
  - **Unmating**
    - **Min** ----- 0.69 Lbs
    - **Max** ----- 0.95 Lbs
- **After 100 Cycles**
  - **Mating**
    - **Min** ----- 1.42 Lbs
    - **Max** ----- 2.09 Lbs
  - **Unmating**
    - **Min** ----- 0.74 Lbs
    - **Max** ----- 1.07 Lbs

**RESULTS Continued****Mating/Unmating Forces****Mating-Unmating Basic Group (MEC2-50-01-L-TH1-WT/EDGE CARD 0.068")**

- **Initial**
  - **Mating**
    - **Min** -----15.37 Lbs
    - **Max** -----17.19 Lbs
  - **Unmating**
    - **Min** -----4.63 Lbs
    - **Max** -----5.60 Lbs
- **After 25 Cycles**
  - **Mating**
    - **Min** -----15.56 Lbs
    - **Max** -----19.47 Lbs
  - **Unmating**
    - **Min** -----5.74 Lbs
    - **Max** -----7.63 Lbs
- **After 50 Cycles**
  - **Mating**
    - **Min** -----16.34 Lbs
    - **Max** -----20.94 Lbs
  - **Unmating**
    - **Min** -----7.07 Lbs
    - **Max** -----8.68 Lbs
- **After 75 Cycles**
  - **Mating**
    - **Min** -----16.63 Lbs
    - **Max** -----21.71 Lbs
  - **Unmating**
    - **Min** -----7.37 Lbs
    - **Max** -----9.39 Lbs
- **After 100 Cycles**
  - **Mating**
    - **Min** -----16.96 Lbs
    - **Max** -----22.29 Lbs
  - **Unmating**
    - **Min** -----7.85 Lbs
    - **Max** -----10.02 Lbs

**Normal Force at 0.0226 inches deflection**

- **Initial**
  - **Min** -----162.40 gf      **Set** ---- 0.0006 in
  - **Max** -----166.10 gf      **Set** ---- 0.0013 in
- **Thermal**
  - **Min** -----104.60 gf      **Set** ---- 0.0057 in
  - **Max** -----118.00 gf      **Set** ---- 0.0074 in

**RESULTS Continued****Insulation Resistance minimums, IR****Pin to Pin**

- **Initial**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed
- **Thermal Shock**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed
- **Humidity**
  - Mated-----8474 Meg  $\Omega$ -----Passed
  - Unmated-----8412 Meg  $\Omega$ -----Passed

**Row to Row**

- **Initial**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed
- **Thermal Shock**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed
- **Humidity**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed

**Pin to Closest Metallic Hardware**

- **Initial**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed
- **Thermal Shock**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed
- **Humidity**
  - Mated-----10000 Meg  $\Omega$ -----Passed
  - Unmated-----10000 Meg  $\Omega$ -----Passed

**Dielectric Withstanding Voltage minimums, DWV**

- **Minimums**
  - Breakdown Voltage-----1125 VAC
  - Test Voltage-----845 VAC
  - Working Voltage-----280 VAC

**Pin to Pin**

- Initial DWV-----Passed
- Thermal DWV-----Passed
- Humidity DWV-----Passed

**Row to Row**

- Initial DWV-----Passed
- Thermal DWV-----Passed
- Humidity DWV-----Passed

**Pin to Closest Metallic Hardware**

- Initial DWV-----Passed
- Thermal DWV-----Passed
- Humidity DWV-----Passed

**RESULTS Continued****LLCR Thermal Aging Group (192 LLCR test points)****MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

- **Initial**-----3.35 mOhms Max
- **Thermal**
  - <= +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

- **Initial**-----3.01 mOhms Max
- **Thermal**
  - <= +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**LLCR Gas Tight Group (192 LLCR test points)****MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

- **Initial**-----3.94 mOhms Max
- **Gas-Tight**
  - <= +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**RESULTS Continued****LLCR Mating/Unmating Durability Group (192 LLCR test points)****MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

- **Initial**-----3.74 mOhms Max
- **Durability, 100 Cycles**
  - ≤ +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure
- **Thermal Shock**
  - ≤ +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure
- **Humidity**
  - ≤ +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

- **Initial**-----3.51 mOhms Max
- **Durability, 100 Cycles**
  - ≤ +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure
- **Thermal Shock**
  - ≤ +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure
- **Humidity**
  - ≤ +5.0 mOhms ----- 192 Points ----- Stable
  - +5.1 to +10.0 mOhms ----- 0 Points ----- Minor
  - +10.1 to +15.0 mOhms ----- 0 Points ----- Acceptable
  - +15.1 to +50.0 mOhms ----- 0 Points ----- Marginal
  - +50.1 to +2000 mOhms ----- 0 Points ----- Unstable
  - >+2000 mOhms ----- 0 Points ----- Open Failure

**RESULTS Continued****LLCR Shock & Vibration Group (192 LLCR test points)****MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

- **Initial**-----4.86 mOhms Max
- **Shock & Vibration**
  - **<= +5.0 mOhms**-----192 Points-----Stable
  - **+5.1 to +10.0 mOhms**-----0 Points-----Minor
  - **+10.1 to +15.0 mOhms**-----0 Points-----Acceptable
  - **+15.1 to +50.0 mOhms**-----0 Points-----Marginal
  - **+50.1 to +2000 mOhms**-----0 Points-----Unstable
  - **>+2000 mOhms**-----0 Points-----Open Failure

**Mechanical Shock & Random Vibration:**

- **Shock**
  - **No Damage**-----Pass
  - **50 Nanoseconds**-----Pass
- **Vibration**
  - **No Damage**-----Pass
  - **50 Nanoseconds**-----Pass

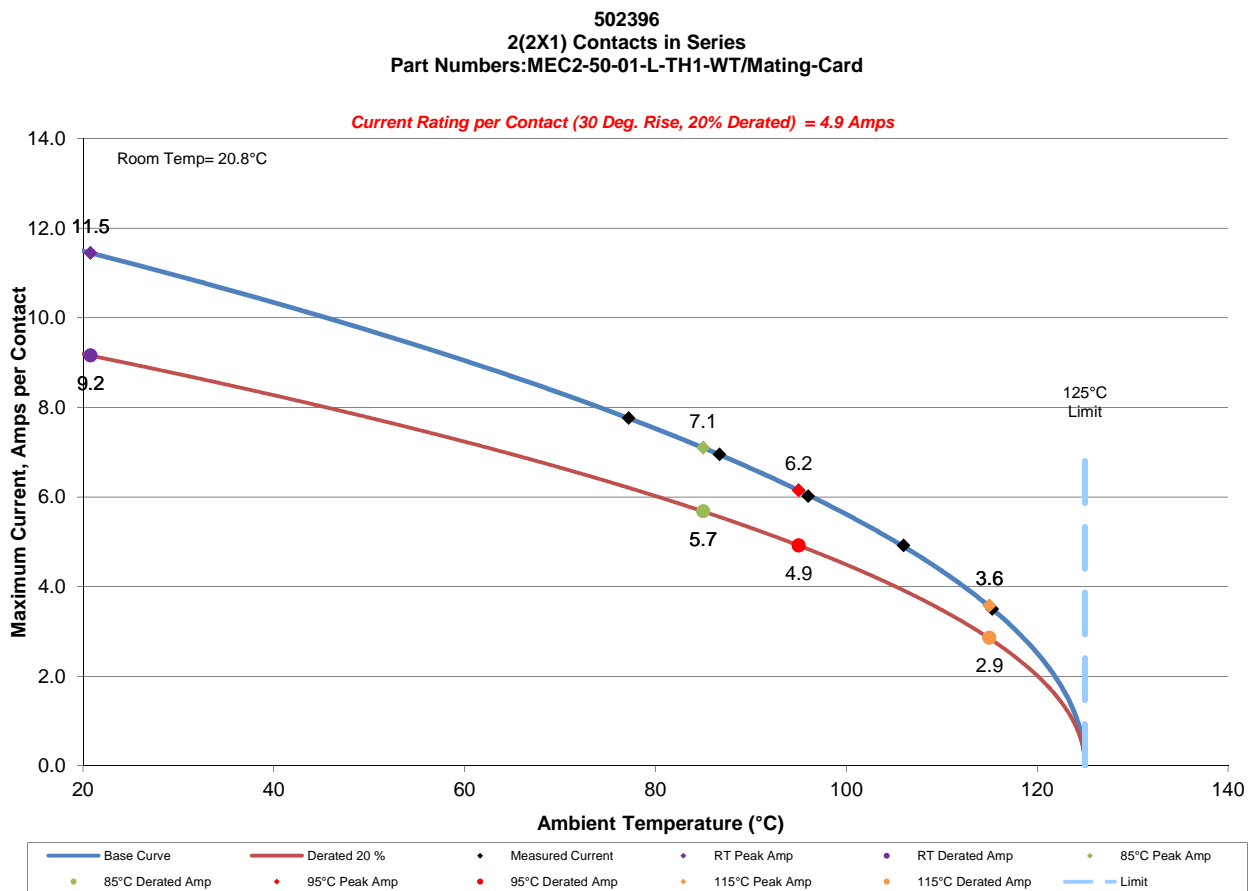
**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

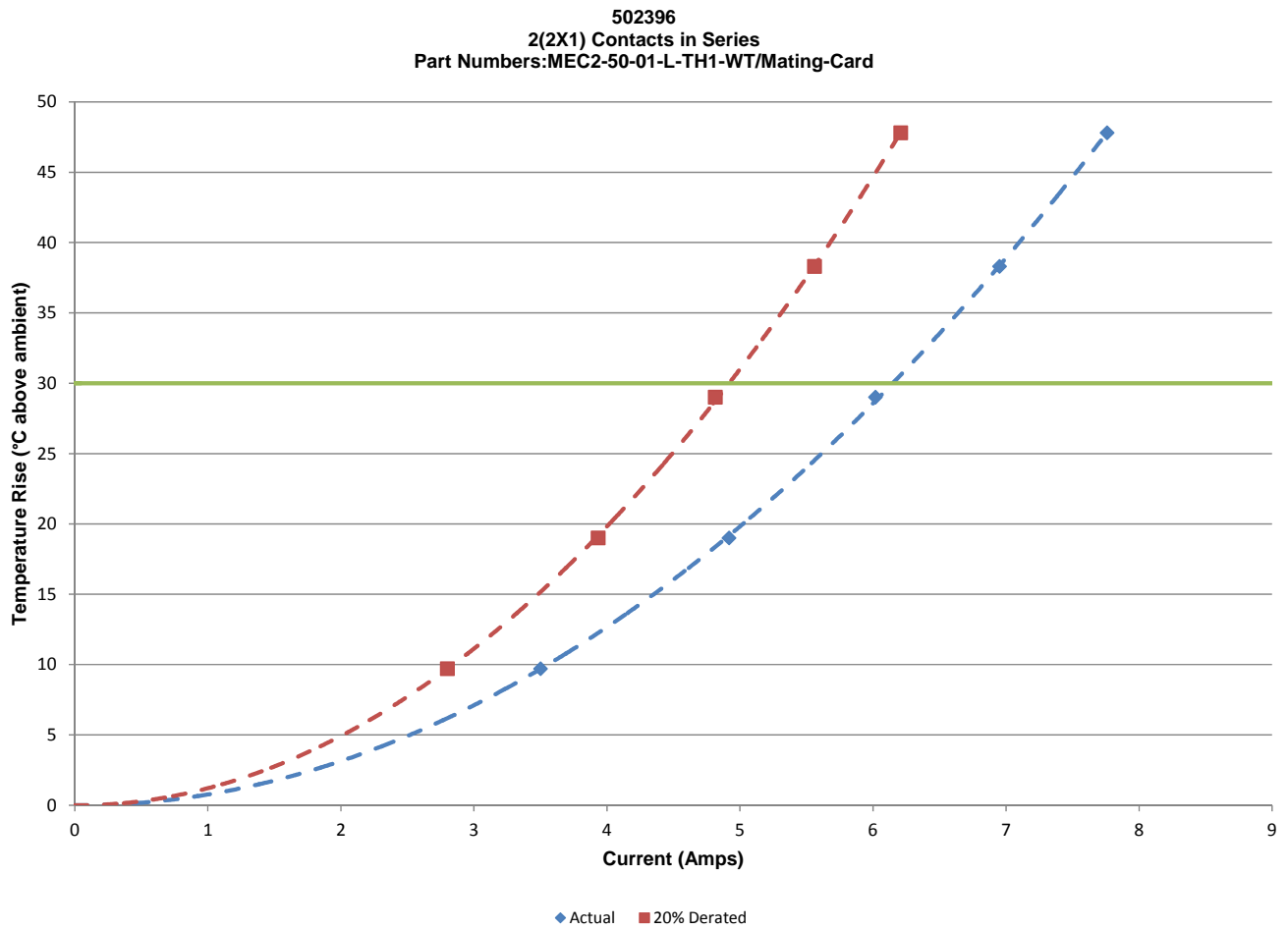
- **Initial**-----3.51 mOhms Max
- **Shock & Vibration**
  - **<= +5.0 mOhms**-----192 Points-----Stable
  - **+5.1 to +10.0 mOhms**-----0 Points-----Minor
  - **+10.1 to +15.0 mOhms**-----0 Points-----Acceptable
  - **+15.1 to +50.0 mOhms**-----0 Points-----Marginal
  - **+50.1 to +2000 mOhms**-----0 Points-----Unstable
  - **>+2000 mOhms**-----0 Points-----Open Failure

## DATA SUMMARIES

### TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
- 2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
- 3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
- 4) Adjacent contacts were powered:
  - a. Linear configuration with 2 adjacent conductors/contacts powered



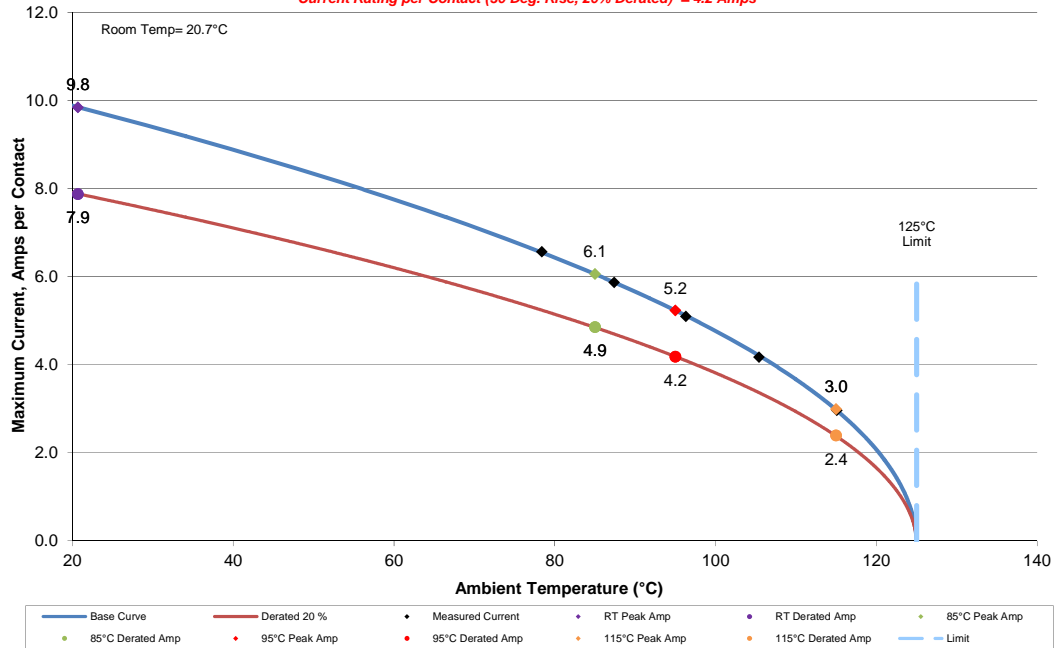


**DATA SUMMARIES Continued****b. Linear configuration with 4 adjacent conductors/contacts powered**

502396

4(2X2) Contacts in Series

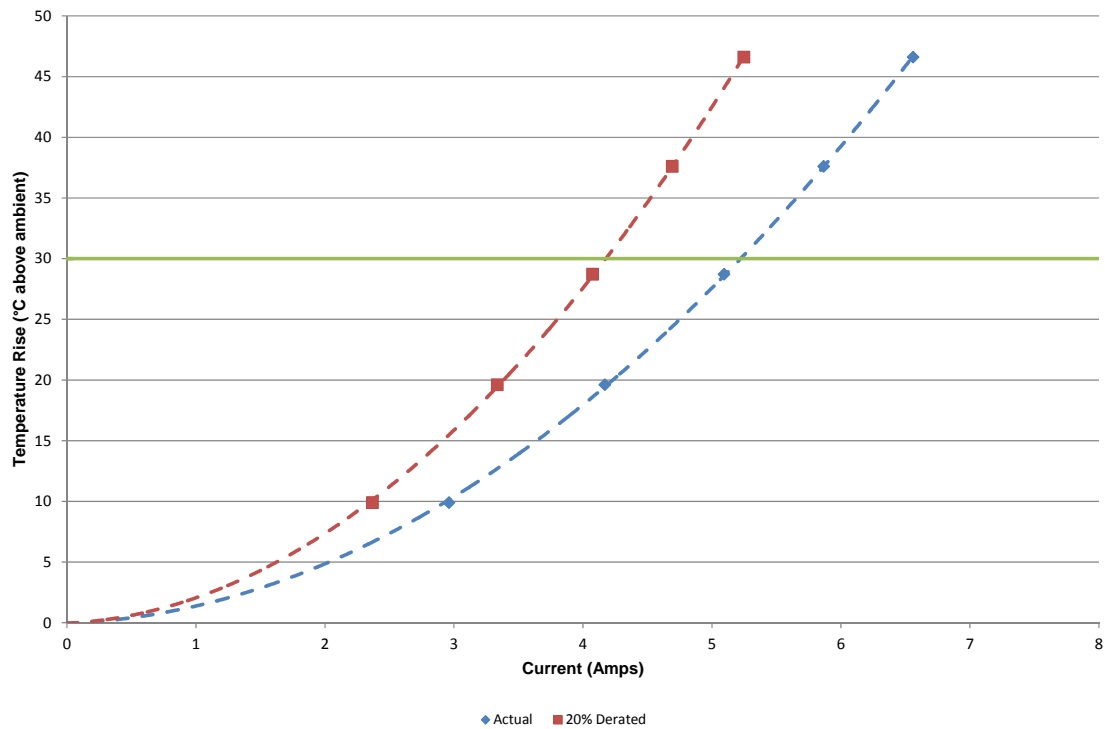
Part Numbers: MEC2-50-01-L-TH1-WT/Mating-Card

*Current Rating per Contact (30 Deg. Rise, 20% Derated) = 4.2 Amps*

502396

4(2X2) Contacts in Series

Part Numbers: MEC2-50-01-L-TH1-WT/Mating-Card

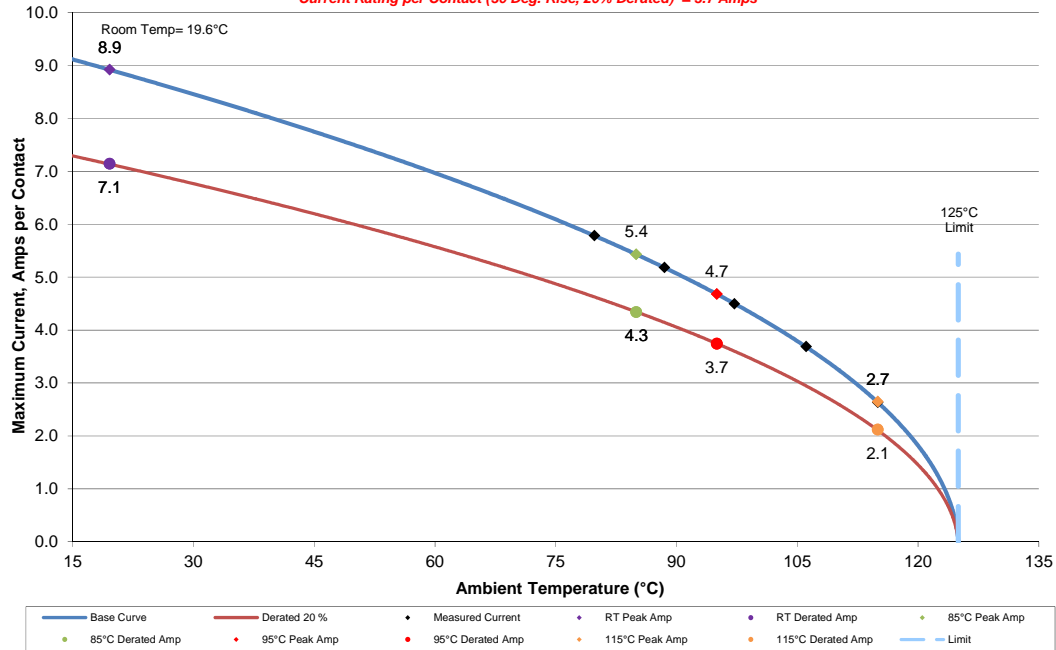


**DATA SUMMARIES Continued****c. Linear configuration with 6 adjacent conductors/contacts powered**

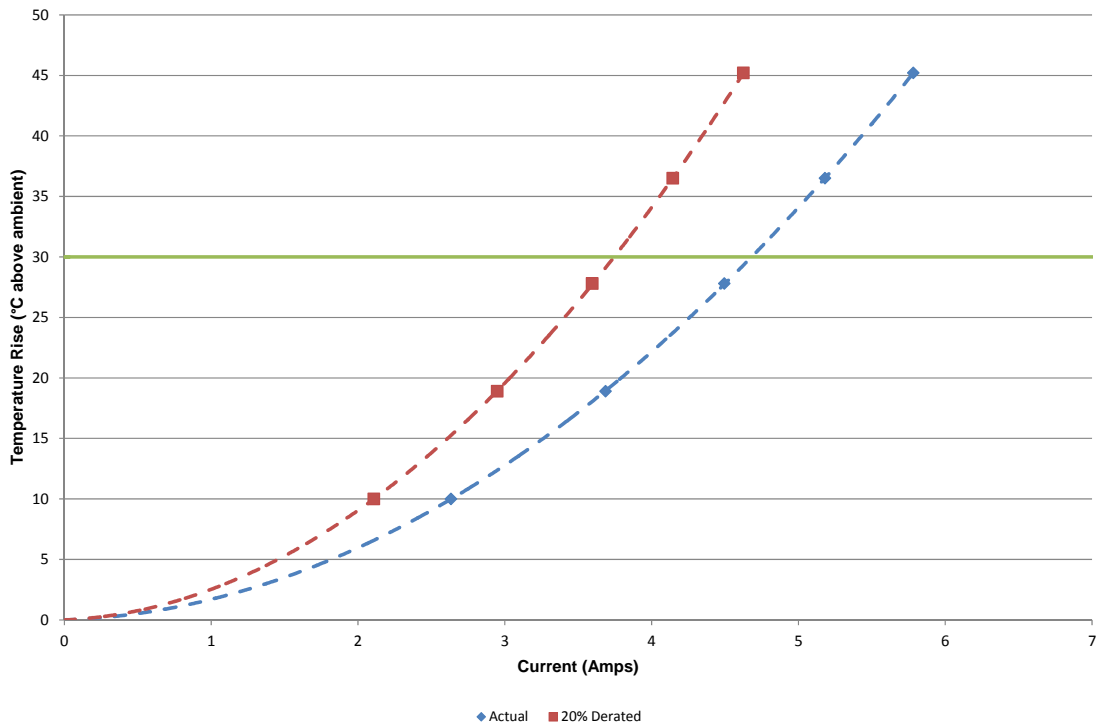
502396

6(2X3) Contacts in Series

Part Numbers: MEC2-50-01-L-TH1-WT/Mating-Card

*Current Rating per Contact (30 Deg. Rise, 20% Derated) = 3.7 Amps*

502396  
6(2X3) Contacts in Series  
Part Numbers: MEC2-50-01-L-TH1-WT/Mating-Card

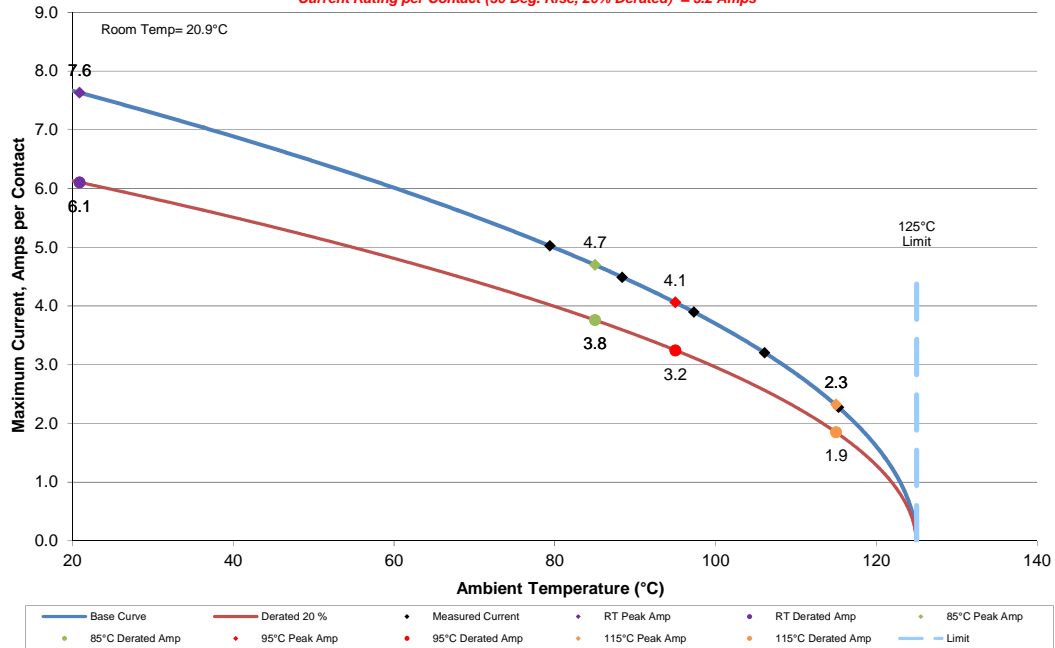


**DATA SUMMARIES Continued****d. Linear configuration with 8 adjacent conductors/contacts powered**

502396

8(2X4) Contacts in Series

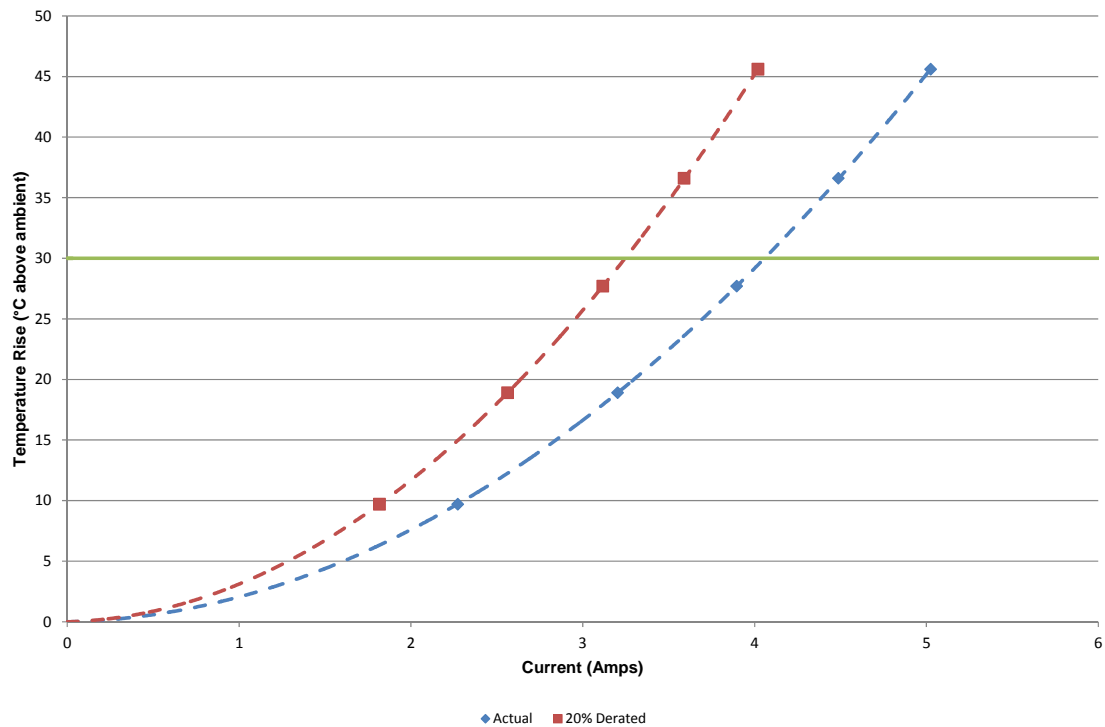
Part Numbers: MEC2-50-01-L-TH1-WT/Mating-Card

*Current Rating per Contact (30 Deg. Rise, 20% Derated) = 3.2 Amps*

502396

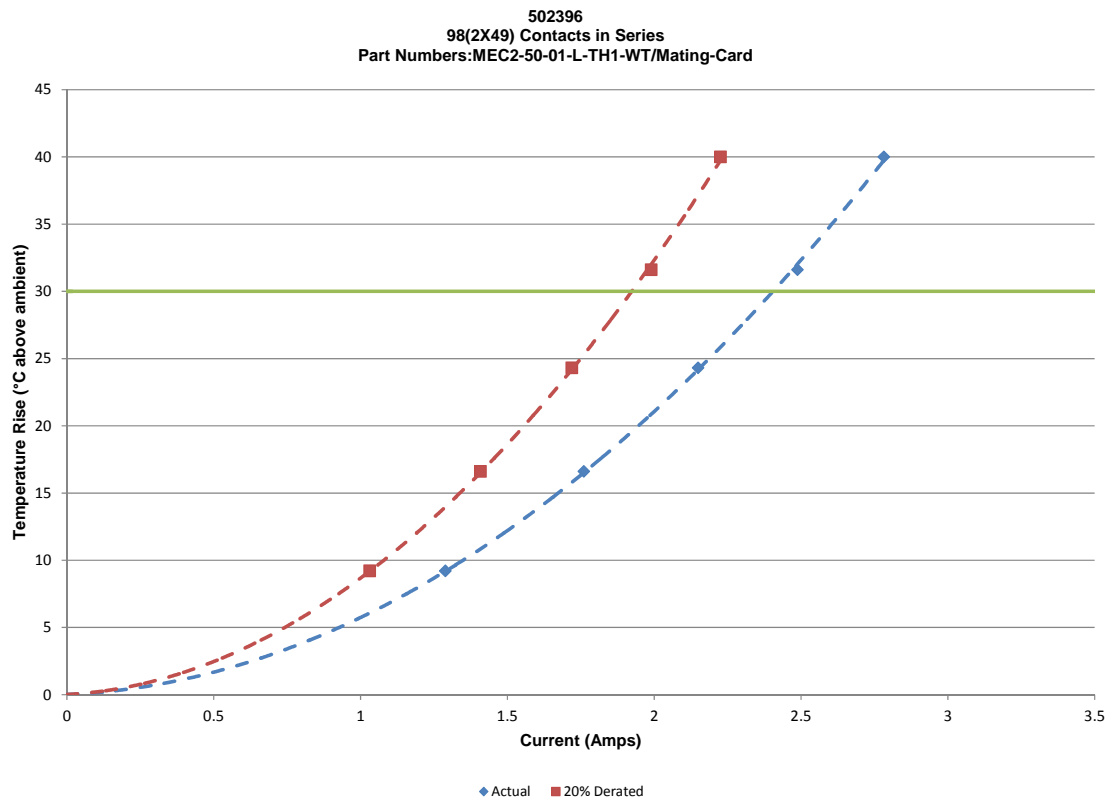
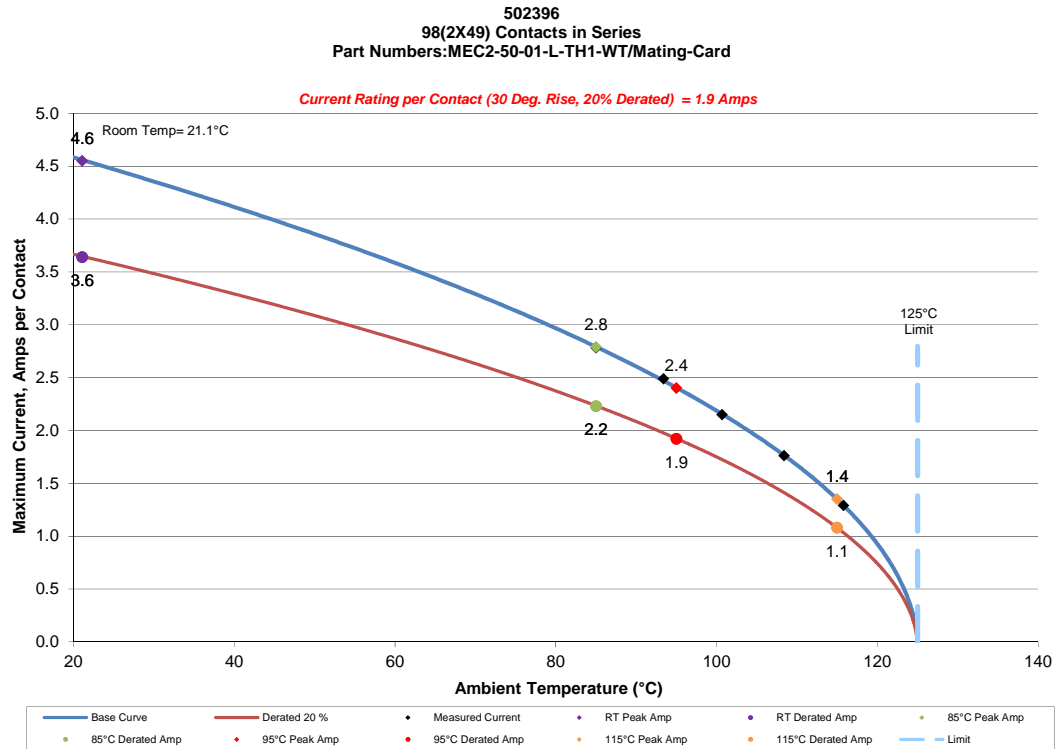
8(2X4) Contacts in Series

Part Numbers: MEC2-50-01-L-TH1-WT/Mating-Card



**DATA SUMMARIES Continued**

e. Linear configuration with all adjacent conductors/contacts powered



**DATA SUMMARIES Continued****MATING-UNMATING FORCE:****Thermal Aging Group****MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

	Initial				After Thermals			
	Mating		Unmating		Mating		Unmating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	41.46	9.32	16.28	3.66	39.14	8.80	17.44	3.92
Maximum	47.50	10.68	19.26	4.33	44.52	10.01	18.19	4.09
<b>Average</b>	44.05	<b>9.90</b>	17.89	<b>4.02</b>	42.21	<b>9.49</b>	17.81	<b>4.00</b>
St Dev	2.20	0.50	1.13	0.25	2.36	0.53	0.33	0.07
Count	8	8	8	8	8	8	8	8

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

	Initial				After Thermals			
	Mating		Unmating		Mating		Unmating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	52.40	11.78	14.46	3.25	45.15	10.15	13.52	3.04
Maximum	63.21	14.21	23.40	5.26	52.04	11.70	17.48	3.93
<b>Average</b>	58.27	<b>13.10</b>	18.94	<b>4.26</b>	48.00	<b>10.79</b>	15.03	<b>3.38</b>
St Dev	3.25	0.73	3.08	0.69	2.24	0.50	1.32	0.30
Count	8	8	8	8	8	8	8	8

## DATA SUMMARIES Continued

## MATING-UNMATING FORCE:

## Mating-Unmating Durability Group (MEC2-30-01-L-TH1-WT/EDGE CARD 0.056")

	Initial				After 25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	32.29	7.26	14.41	3.24	43.32	9.74	18.99	4.27
Maximum	42.43	9.54	18.50	4.16	53.87	12.11	22.86	5.14
<b>Average</b>	<b>38.27</b>	<b>8.60</b>	<b>16.56</b>	<b>3.72</b>	<b>48.26</b>	<b>10.85</b>	<b>21.12</b>	<b>4.75</b>
St Dev	3.52	0.79	1.58	0.35	4.62	1.04	1.32	0.30
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	47.59	10.70	21.66	4.87	52.71	11.85	23.17	5.21
Maximum	64.18	14.43	26.55	5.97	68.94	15.50	29.71	6.68
<b>Average</b>	<b>56.33</b>	<b>12.67</b>	<b>24.25</b>	<b>5.45</b>	<b>61.58</b>	<b>13.85</b>	<b>26.47</b>	<b>5.95</b>
St Dev	6.79	1.53	1.68	0.38	6.44	1.45	2.12	0.48
Count	8	8	8	8	8	8	8	8
	After 100 Cycles				After Humidity			
	Mating		Unmating		Mating		Unmating	
	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)	Newtons	Force (Lbs)
Minimum	54.22	12.19	24.55	5.52	27.09	6.09	13.34	3.00
Maximum	72.68	16.34	32.83	7.38	37.32	8.39	18.15	4.08
<b>Average</b>	<b>65.10</b>	<b>14.64</b>	<b>28.65</b>	<b>6.44</b>	<b>32.48</b>	<b>7.30</b>	<b>16.17</b>	<b>3.64</b>
St Dev	6.73	1.51	2.90	0.65	3.47	0.78	1.80	0.40
Count	8	8	8	8	8	8	8	8

## DATA SUMMARIES Continued

## MATING-UNMATING FORCE:

## Mating-Unmating Durability Group (MEC2-30-01-L-TH1-WT/EDGE CARD 0.068")

	Initial				After 25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	48.97	11.01	14.72	3.31	56.00	12.59	18.82	4.23
Maximum	61.20	13.76	19.08	4.29	69.43	15.61	24.82	5.58
<b>Average</b>	53.06	<b>11.93</b>	16.61	<b>3.73</b>	63.62	<b>14.30</b>	21.94	<b>4.93</b>
St Dev	3.91	0.88	1.38	0.31	4.52	1.02	1.89	0.42
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	59.47	13.37	20.91	4.70	61.56	13.84	26.78	6.02
Maximum	80.06	18.00	30.34	6.82	84.16	18.92	37.54	8.44
<b>Average</b>	71.33	<b>16.04</b>	26.49	<b>5.96</b>	75.17	<b>16.90</b>	30.79	<b>6.92</b>
St Dev	7.54	1.70	3.35	0.75	8.13	1.83	3.92	0.88
Count	8	8	8	8	8	8	8	8
	After 100 Cycles				After Humidity			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	63.38	14.25	28.51	6.41	36.34	8.17	12.77	2.87
Maximum	86.56	19.46	40.30	9.06	47.86	10.76	15.66	3.52
<b>Average</b>	77.77	<b>17.49</b>	33.42	<b>7.51</b>	41.14	<b>9.25</b>	14.28	<b>3.21</b>
St Dev	8.38	1.88	3.98	0.89	4.19	0.94	0.97	0.22
Count	8	8	8	8	8	8	8	8

## DATA SUMMARIES Continued

## MATING-UNMATING FORCE:

## Mating-Unmating Basic (MEC2-05-01-L-TH1-WT/EDGE CARD 0.068")

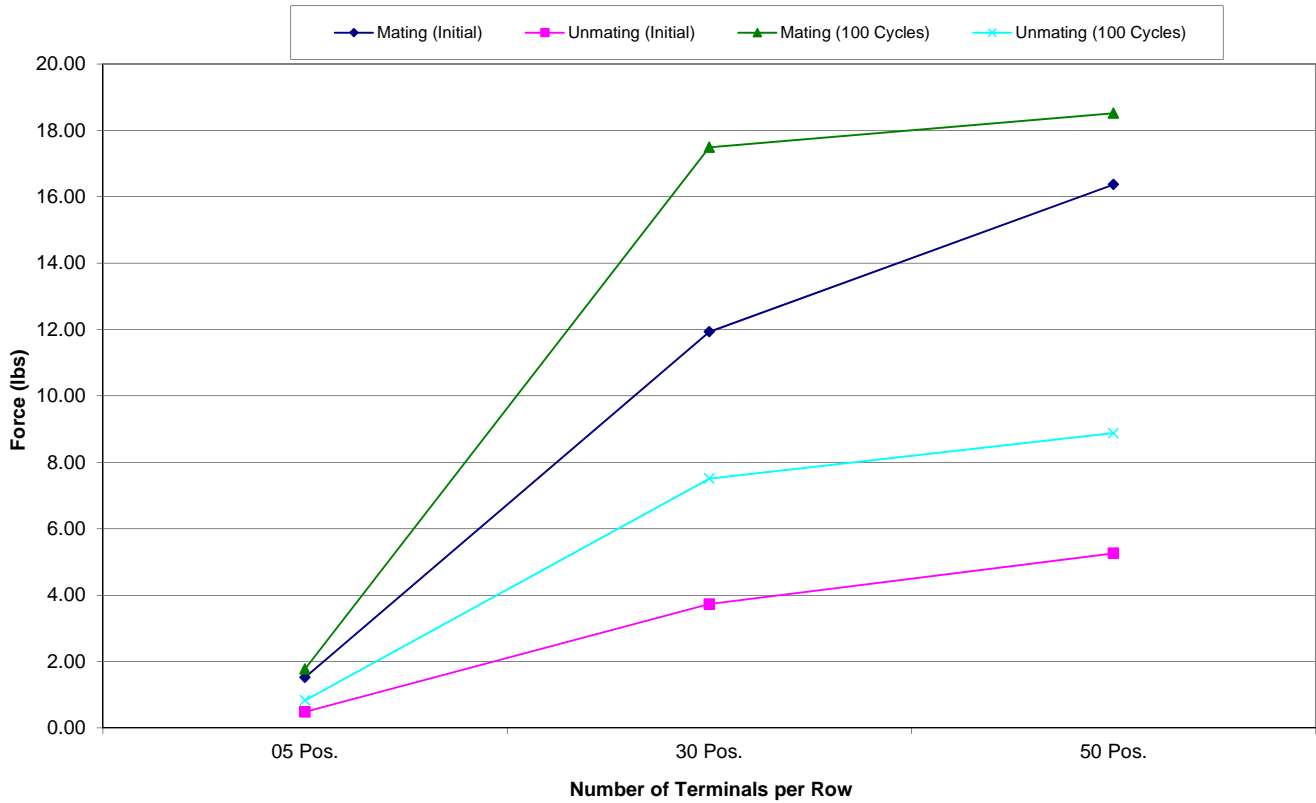
	Initial				After 25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	5.87	1.32	1.82	0.41	6.54	1.47	2.45	0.55
Maximum	7.70	1.73	2.45	0.55	7.78	1.75	3.29	0.74
<b>Average</b>	6.74	<b>1.52</b>	2.15	<b>0.48</b>	7.29	<b>1.64</b>	2.79	<b>0.63</b>
St Dev	0.71	0.16	0.18	0.04	0.50	0.11	0.24	0.06
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	5.87	1.32	2.76	0.62	6.09	1.37	3.07	0.69
Maximum	8.58	1.93	3.65	0.82	8.98	2.02	4.23	0.95
<b>Average</b>	7.21	<b>1.62</b>	3.11	<b>0.70</b>	7.57	<b>1.70</b>	3.44	<b>0.77</b>
St Dev	1.04	0.23	0.28	0.06	1.08	0.24	0.38	0.08
Count	8	8	8	8	8	8	8	8
	After 100 Cycles							
	Mating		Unmating					
	Newton's	Force (Lbs)	Newton's	Force (Lbs)				
Minimum	6.32	1.42	3.29	0.74				
Maximum	9.30	2.09	4.76	1.07				
<b>Average</b>	7.86	<b>1.77</b>	3.69	<b>0.83</b>				
St Dev	1.09	0.24	0.48	0.11				
Count	8	8	8	8				

## DATA SUMMARIES Continued

## MATING-UNMATING FORCE:

## Mating-Unmating Basic (MEC2-50-01-L-TH1-WT /EDGE CARD 0.068")

	Initial				After 25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	68.37	15.37	20.59	4.63	69.21	15.56	25.53	5.74
Maximum	76.46	17.19	24.91	5.60	86.60	19.47	33.94	7.63
Average	72.80	16.37	23.39	5.26	74.73	16.80	30.54	6.87
St Dev	2.93	0.66	1.44	0.32	5.62	1.26	2.64	0.59
Count	8	8	8	8	8	8	8	8
	After 50 Cycles				After 75 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)	Newton	Force (Lbs)
Minimum	72.68	16.34	31.45	7.07	73.97	16.63	32.78	7.37
Maximum	93.14	20.94	38.61	8.68	96.57	21.71	41.77	9.39
Average	77.91	17.52	34.80	7.82	80.38	18.07	37.37	8.40
St Dev	6.77	1.52	2.51	0.56	7.62	1.71	2.97	0.67
Count	8	8	8	8	8	8	8	8
	After 100 Cycles							
	Mating		Unmating					
	Newton	Force (Lbs)	Newton	Force (Lbs)				
Minimum	75.44	16.96	34.92	7.85				
Maximum	99.15	22.29	44.57	10.02				
Average	82.38	18.52	39.49	8.88				
St Dev	8.33	1.87	3.04	0.68				
Count	8	8	8	8				

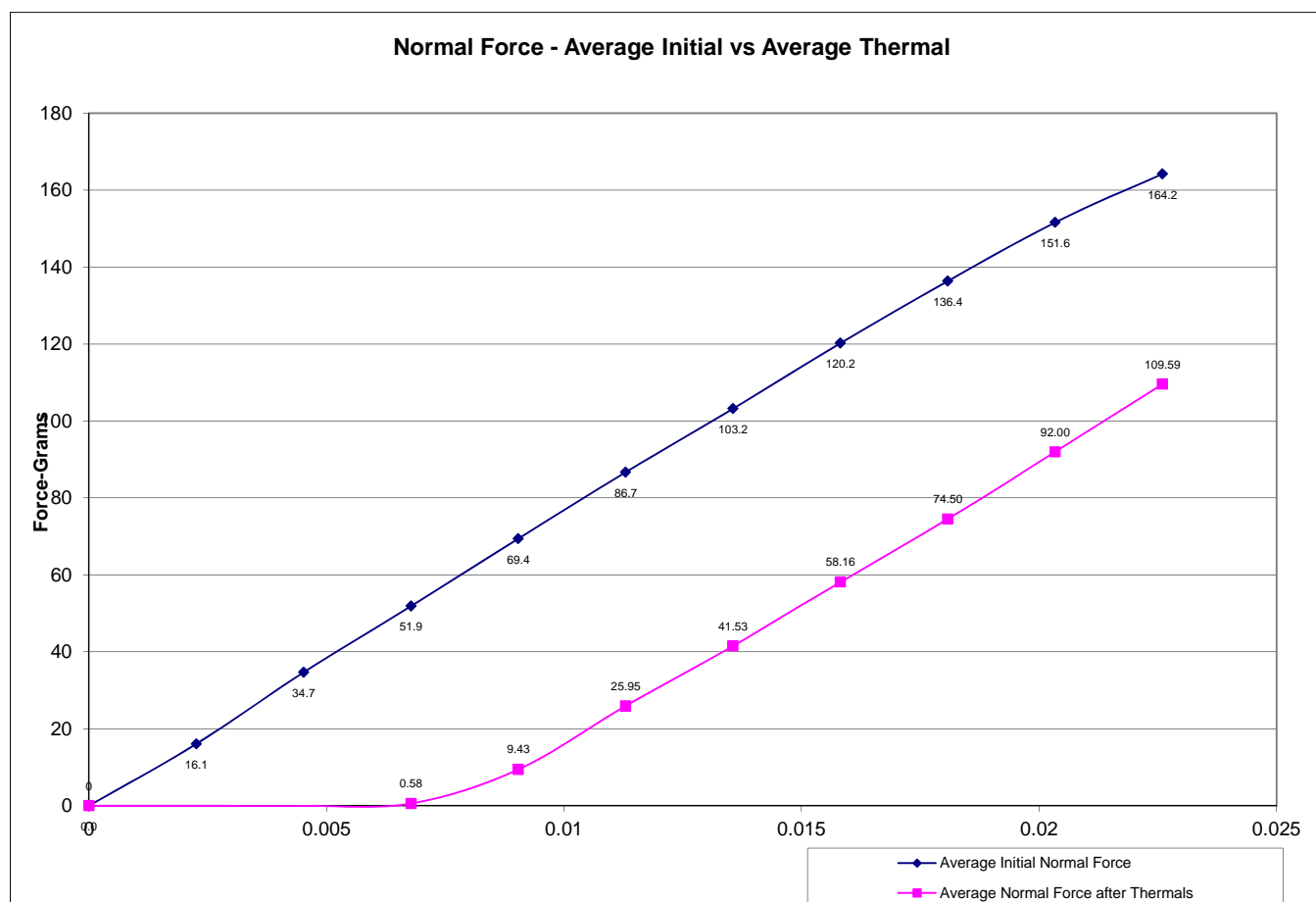
**DATA SUMMARIES Continued****Mating\Unmating Force Comparison****Mating/Unmating Data for 05, 30 and 50 Position MEC2/Card 0.068"**

**DATA SUMMARIES Continued****NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):**

- 1) Calibrated force gauges are used along with computer controlled positioning equipment.
- 2) For Normal force 8-10 measurements are taken and the averages reported.

Initial	Deflections in inches Forces in Grams										
	<b>0.0023</b>	<b>0.0045</b>	<b>0.0068</b>	<b>0.0090</b>	<b>0.0113</b>	<b>0.0136</b>	<b>0.0158</b>	<b>0.0181</b>	<b>0.0203</b>	<b>0.0226</b>	<b>SET</b>
<b>Averages</b>	16.07	34.69	51.88	69.43	86.71	103.23	120.24	136.36	151.63	164.23	0.0010
<b>Min</b>	11.80	30.80	48.00	65.10	82.30	99.00	115.30	131.70	149.10	162.40	0.0006
<b>Max</b>	17.30	36.00	53.20	71.40	89.40	106.50	122.60	139.50	154.60	166.10	0.0013
<b>St. Dev</b>	1.510	1.429	1.498	1.847	2.083	1.943	1.936	2.212	1.542	1.383	0.0002
<b>Count</b>	12	12	12	12	12	12	12	12	12	12	12

After Thermals	Deflections in inches Forces in Grams										
	<b>0.0023</b>	<b>0.0045</b>	<b>0.0068</b>	<b>0.0090</b>	<b>0.0113</b>	<b>0.0136</b>	<b>0.0158</b>	<b>0.0181</b>	<b>0.0203</b>	<b>0.0226</b>	<b>SET</b>
<b>Averages</b>	-0.01	-0.03	0.58	9.43	25.95	41.53	58.16	74.50	92.00	109.59	0.0069
<b>Min</b>	-0.10	-0.10	-0.10	6.40	22.50	37.60	53.20	69.30	86.40	104.60	0.0057
<b>Max</b>	0.10	0.10	4.30	17.40	33.80	49.40	65.90	82.90	100.20	118.00	0.0074
<b>St. Dev</b>	0.079	0.065	1.377	3.304	3.228	3.295	3.651	3.994	4.080	3.947	0.0005
<b>Count</b>	12	12	12	12	12	12	12	12	12	12	12



**DATA SUMMARIES Continued****INSULATION RESISTANCE (IR):**

	Pin to Pin		
	Mated	Unmated	Unmated
Minimum	MEC2/Card	MEC2	Card
Initial	10000	10000	Not Tested
Thermal	10000	10000	Not Tested
Humidity	8412	8474	Not Tested

	Row to Row		
	Mated	Unmated	Unmated
Minimum	MEC2/Card	MEC2	Card
Initial	10000	10000	Not Tested
Thermal	10000	10000	Not Tested
Humidity	10000	10000	Not Tested

	Pin to Closest Metallic Hardware		
	Mated	Unmated	Unmated
Minimum	MEC2/Card	MEC2	Card
Initial	10000	10000	Not Tested
Thermal	10000	10000	Not Tested
Humidity	10000	10000	Not Tested

**DATA SUMMARIES Continued****DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

Voltage Rating Summary	
Minimum	MEC2/Card
Break Down Voltage	1125
Test Voltage	845
Working Voltage	280

Pin to Pin	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

Row to Row	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

Pin to Closest Metallic Hardware	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

**DATA SUMMARIES Continued****LLCR Thermal Aging Group**

- 1) A total of 192 points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
  - a.  $\leq +5.0$  mOhms:-----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms:-----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms:-----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms:-----Marginal
  - e.  $+50.1$  to  $+2000$  mOhms:-----Unstable
  - f.  $>+2000$  mOhms:-----Open Failure

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

<b>LLCR Measurement Summaries by Pin Type</b>				
Date	2/9/2015	3/11/2015		
Room Temp (Deg C)	21	19		
Rel Humidity (%)	35	58		
Technician	Kason He	Kason He		
mOhm values	<b>Actual Initial</b>	<b>Delta Thermal</b>	<b>Delta</b>	<b>Delta</b>
Card 0.056"	<b>Pin Type 1: Signal</b>			
Average	2.64	1.85		
St. Dev.	0.16	1.10		
Min	2.33	0.01		
Max	3.35	4.97		
Summary Count	192	192		
Total Count	192	192		

<b>LLCR Delta Count by Category</b>						
	<b>Stable</b>	<b>Minor</b>	<b>Acceptable</b>	<b>Marginal</b>	<b>Unstable</b>	<b>Open</b>
mOhms	<b><math>\leq 5</math></b>	<b><math>&gt;5 \text{ \&amp; } \leq 10</math></b>	<b><math>&gt;10 \text{ \&amp; } \leq 15</math></b>	<b><math>&gt;15 \text{ \&amp; } \leq 50</math></b>	<b><math>&gt;50 \text{ \&amp; } \leq 1000</math></b>	<b><math>&gt;1000</math></b>
Thermal	192	0	0	0	0	0

Tracking Code: 502396 Report Rev 1	Part #: MEC2-30-01-L-TH1-WT/EDGE CARD
Part description: MEC2/CARD	

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

LLCR Measurement Summaries by Pin Type				
Date	2/9/2015	3/11/2015		
Room Temp (Deg C)	21	19		
Rel Humidity (%)	35	58		
Technician	Kason He	Kason He		
mOhm values	Actual Initial	Delta Thermal	Delta	Delta
Card 0.068"	Pin Type 1: Signal			
Average	2.52	0.79		
St. Dev.	0.16	0.86		
Min	2.12	0.01		
Max	3.01	4.62		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Thermal	192	0	0	0	0	0

**DATA SUMMARIES Continued****LLCR Mating/Unmating Durability Group**

- 1). A total of 192 points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
  - a.  $\leq +5.0$  mOhms:-----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+2000$  mOhms-----Unstable
  - f.  $> +2000$  mOhms:-----Open Failure

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

<b>LLCR Measurement Summaries by Pin Type</b>				
Date	2/9/2015	2/11/2015	3/6/2015	3/18/2015
Room Temp (Deg C)	21	22	20	22
Rel Humidity (%)	35	42	54	62
Technician	Kason He	Kason He	Kason He	Kason He
mOhm values	<b>Actual Initial</b>	<b>Delta 100 Cycles</b>	<b>Delta Therm Shck</b>	<b>Delta Humidity</b>
Card 0.056"	<b>Pin Type 1: Signal</b>			
Average	2.83	0.28	0.39	0.79
St. Dev.	0.29	0.23	0.31	0.76
Min	2.34	0.01	0.00	0.00
Max	3.74	1.19	1.40	3.22
Summary Count	192	192	192	192
Total Count	192	192	192	192

<b>LLCR Delta Count by Category</b>						
	<b>Stable</b>	<b>Minor</b>	<b>Acceptable</b>	<b>Marginal</b>	<b>Unstable</b>	<b>Open</b>
mOhms	<b><math>\leq 5</math></b>	<b><math>&gt; 5 \text{ \&amp; } \leq 10</math></b>	<b><math>&gt; 10 \text{ \&amp; } \leq 15</math></b>	<b><math>&gt; 15 \text{ \&amp; } \leq 50</math></b>	<b><math>&gt; 50 \text{ \&amp; } \leq 1000</math></b>	<b><math>&gt; 1000</math></b>
100 Cycles	192	0	0	0	0	0
Therm Shck	192	0	0	0	0	0
Humidity	192	0	0	0	0	0

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

<b>LLCR Measurement Summaries by Pin Type</b>				
Date	2/9/2015	2/11/2015	3/6/2015	3/18/2015
Room Temp (Deg C)	21	22	20	22
Rel Humidity (%)	35	42	54	62
Technician	Kason He	Kason He	Kason He	Kason He
mOhm values	<b>Actual Initial</b>	<b>Delta 100 Cycles</b>	<b>Delta Therm Shck</b>	<b>Delta Humidity</b>
Card 0.068"	<b>Pin Type 1: Signal</b>			
Average	2.70	0.22	0.32	1.53
St. Dev.	0.28	0.21	0.27	1.02
Min	2.16	0.00	0.00	0.00
Max	3.51	1.06	1.45	3.97
Summary Count	192	192	192	192
Total Count	192	192	192	192

<b>LLCR Delta Count by Category</b>						
	<b>Stable</b>	<b>Minor</b>	<b>Acceptable</b>	<b>Marginal</b>	<b>Unstable</b>	<b>Open</b>
<b>mOhms</b>	<b>&lt;=5</b>	<b>&gt;5 &amp; &lt;=10</b>	<b>&gt;10 &amp; &lt;=15</b>	<b>&gt;15 &amp; &lt;=50</b>	<b>&gt;50 &amp; &lt;=1000</b>	<b>&gt;1000</b>
<b>100 Cycles</b>	192	0	0	0	0	0
<b>Therm Shck</b>	192	0	0	0	0	0
<b>Humidity</b>	192	0	0	0	0	0

**DATA SUMMARIES Continued****LLCR Gas Tight Group**

- 1) A total of 192 points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
  - a.  $\leq +5.0$  mOhms:-----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms:-----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms:-----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms:-----Marginal
  - e.  $+50.1$  to  $+2000$  mOhms:-----Unstable
  - f.  $>+2000$  mOhms:-----Open Failure

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

<b>LLCR Measurement Summaries by Pin Type</b>				
Date	3/3/2015	3/3/2015		
Room Temp (Deg C)	22	22		
Rel Humidity (%)	53	53		
Technician	Kason He	Kason He		
mOhm values	<b>Actual</b>	<b>Delta</b>	<b>Delta</b>	<b>Delta</b>
	<b>Initial</b>	<b>Acid Vapor</b>		
<b>Pin Type 1: Signal</b>				
Average	2.96	0.41		
St. Dev.	0.34	0.32		
Min	2.32	0.01		
Max	3.94	1.96		
Summary Count	192	192		
Total Count	192	192		

<b>LLCR Delta Count by Category</b>						
	<b>Stable</b>	<b>Minor</b>	<b>Acceptable</b>	<b>Marginal</b>	<b>Unstable</b>	<b>Open</b>
mOhms	$\leq 5$	$>5 \text{ \& } \leq 10$	$>10 \text{ \& } \leq 15$	$>15 \text{ \& } \leq 50$	$>50 \text{ \& } \leq 1000$	$>1000$
<b>Acid Vapor</b>	192	0	0	0	0	0

**DATA SUMMARIES Continued****LLCR Shock & Vibration Group**

- 1) A total of 192 points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+2000$  mOhms: -----Unstable
  - f.  $>+2000$  mOhms: -----Open Failure

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.056"**

<b>LLCR Measurement Summaries by Pin Type</b>				
Date	4/10/2015	4/16/2015		
Room Temp (Deg C)	22	22		
Rel Humidity (%)	40	44		
Technician	Tony Wagoner	Tony Wagoner		
<b>mOhm values</b>	<b>Actual Initial</b>	<b>Delta Shock-Vib</b>	<b>Delta</b>	<b>Delta</b>
<b>Pin Type 1: Signal</b>				
Average	2.93	0.31		
St. Dev.	0.37	0.32		
Min	2.26	0.00		
Max	4.86	2.31		
Summary Count	192	192		
Total Count	192	192		

<b>LLCR Delta Count by Category</b>						
	<b>Stable</b>	<b>Minor</b>	<b>Acceptable</b>	<b>Marginal</b>	<b>Unstable</b>	<b>Open</b>
<b>mOhms</b>	<b><math>\leq 5</math></b>	<b><math>&gt;5</math> &amp; <math>\leq 10</math></b>	<b><math>&gt;10</math> &amp; <math>\leq 15</math></b>	<b><math>&gt;15</math> &amp; <math>\leq 50</math></b>	<b><math>&gt;50</math> &amp; <math>\leq 1000</math></b>	<b><math>&gt;1000</math></b>
<b>Shock-Vib</b>	192	0	0	0	0	0

**Nanosecond Event Detection:**

<b>Shock and Vibration Event Detection Summary</b>	
Contacts tested	60
Test Condition	C, 100g's, 6ms, Half-Sine
Shock Events	0
Test Condition	V-B, 7.56 rms g
Vibration Events	0
<b>Total Events</b>	<b>0</b>

Tracking Code: 502396 Report Rev 1	Part #: MEC2-30-01-L-TH1-WT/EDGE CARD
Part description: MEC2/CARD	

**MEC2-30-01-L-TH1-WT/EDGE CARD 0.068"**

LLCR Measurement Summaries by Pin Type				
Date	4/15/2015	4/17/2015		
Room Temp (Deg C)	22	21		
Rel Humidity (%)	34	44		
Technician	Tony Wagoner	Tony Wagoner		
mOhm values	Actual	Delta	Delta	Delta
	Initial	Shock-Vib		
Pin Type 1: Signal				
Average	2.60	0.13		
St. Dev.	0.27	0.14		
Min	2.06	0.00		
Max	3.51	1.20		
Summary Count	192	192		
Total Count	192	192		

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Shock-Vib	192	0	0	0	0	0

**EQUIPMENT AND CALIBRATION SCHEDULES****Equipment #:** HZ-TCT-01**Description:** Normal force analyzer**Manufacturer:** Mecmesin Multitester**Model:** Mecmesin Multitester 2.5-i**Serial #:** 08-1049-04**Accuracy:** Last Cal: 4/25/2014, Next Cal: 4/24/2015**Equipment #:** HZ-OV-01**Description:** Oven**Manufacturer:** Huida**Model:** CS101-1E**Serial #:** CS101-1E-B**Accuracy:** Last Cal: 12/11/2014, Next Cal: 12/10/2015**Equipment #:** HZ-THC-01**Description:** Humidity transmitter**Manufacturer:** Thermtron**Model:** SM-8-8200**Serial #:** 38846**Accuracy:** Last Cal: 2/26/2015, Next Cal: 2/25/2016**Equipment #:** HZ-HPM-01**Description:** NA9636H**Manufacturer:** Ainuo**Model:** 6031A**Serial #:** 089601091**Accuracy:** Last Cal: 3/5/2015, Next Cal: 3/4/2016**Equipment #:** HZ-MO-05**Description:** Micro-ohmmeter**Manufacturer:** Keithley**Model:** 3706**Serial #:** 1285188**Accuracy:** Last Cal: 11/13/2014, Next Cal: 11/12/2015**Equipment #:** HZ-TSC-01**Description:** Vertical Thermal Shock Chamber**Manufacturer:** Cincinnatti Sub Zero**Model:** VTS-3-6-6-SC/AC**Serial #:** 10-VT14994**Accuracy:** See Manual

... Last Cal: 06/26/2014, Next Cal: 06/25/2015

**Equipment #:** HZ-PS-01**Description:** 120 Amp Power Supply**Manufacturer:** Agilent**Model:** 6031A PS**Serial #:** MY41000982**Accuracy:** See Manual

... Last Cal: 07/02/2014, Next Cal: 07/01/2015

**EQUIPMENT AND CALIBRATION SCHEDULES Continued****Equipment #:** HZ-MO-01**Description:** Multimeter /Data Acquisition System**Manufacturer:** Keithley**Model:** 2700**Serial #:** 1199807**Accuracy:** See Manual

... Last Cal: 07/02/2014, Next Cal: 07/01/2015

**Equipment #:** MO-11**Description:** Switch/Multimeter**Manufacturer:** Keithley**Model:** 3706**Serial #:** 120169**Accuracy:** See Manual

... Last Cal: 08/21/2014, Next Cal: 08/21/2015

**Equipment #:** SVC-01**Description:** Shock & Vibration Table**Manufacturer:** Data Physics**Model:** LE-DSA-10-20K**Serial #:** 10037**Accuracy:** See Manual

... Last Cal: 11/31/2014, Next Cal: 11/31/2015

**Equipment #:** ACLM-01**Description:** Accelerometer**Manufacturer:** PCB Piezotronics**Model:** 352C03**Serial #:** 115819**Accuracy:** See Manual

... Last Cal: 07/09/2014, Next Cal: 07/09/2015

**Equipment #:** ED-03**Description:** Event Detector**Manufacturer:** Analysis Tech**Model:** 32EHD**Serial #:** 1100604**Accuracy:** See Manual

... Last Cal: 06/04/2014, Next Cal: 06/04/2015